











PRODUCT DATASHEET



- ► PLCC2 Top View
- ➤ 3020HC 0.8t Series
- ► Cool White (6500K)

NOW58S32 (CRI 90)





3020 0.8t Series





FEATURES:

- Package: PLCC White Top View SMT Package
- Forward Current: 20mA
- Forward Voltage (typ.): 3.2V
- Luminous Intensity (typ.): 2200mcd@20mA
- Colour: Cool White
- **CCT (typ.):** 6500K
- Viewing angle: 120°
- Materials:
 - Die: InGaN
 - Resin: Silicon (Yellow Diffused)
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- ESD: 500V
- Grouping parameters:
 - Forward voltage
 - Luminous intensity
 - CIE Chromaticity
- Soldering methods: IR Reflow soldering
- Preconditioning: acc. to JEDEC Level 3
- Packing: 8mm tape with max.2000/reel, ø180mm (7")

APPLICATIONS:

- LCD Backlighting
- General Lighting
- Commercial LightingResidential Lighting
- Architectural Lighting
- Flash Lighting



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	IF	30	mA
Peak Forward Current Duty 1/10@10KHz	I _{FP}	100	mA
Power Dissipation	P _D	108	mW
Reverse Current @5V	I _R	50	μΑ
Electrostatic Discharge	ESD	500	V
Operating Temperature	TOPR	-40~+85	°C
Storage Temperature	T _{STG}	-40~+100	°C
Colour Rendering Index	CRI	90	

Electrical & Optical Characteristics (Ta=25°C)

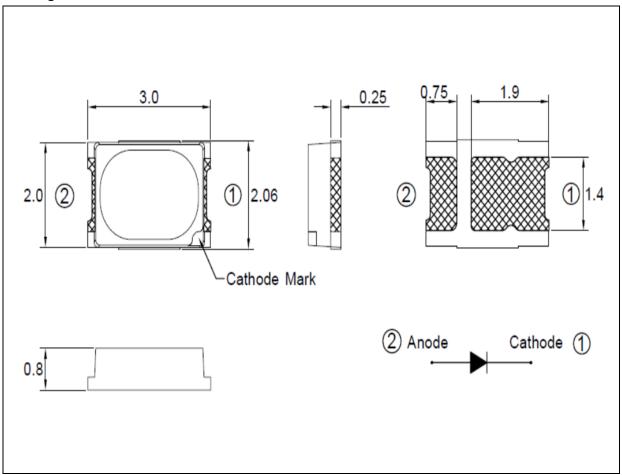
Darameter	Cumbal	Values			Lloit	Test	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Condition	
Forward Voltage	V _F	2.8		3.6	V	I _F =20mA	
Luminous Intensity	lv	1800	2200		mcd	I _F =20mA	
Chromaticity	Х	0.3028		0.3221		I _F =20mA	
Coordinates	Υ	0.3113		0.3481			
Colour Temperature	ССТ	6020	6500	7040	К		
Viewing Angle	2θ _{1/2}		120		deg	I _F =20mA	

^{1.} Luminous intensity (I_V) $\pm 15\%$, Forward Voltage (V_F) $\pm 0.1V$, Viewing angle($2\theta_{1/2}$) $\pm 5\%$, CRI ± 3



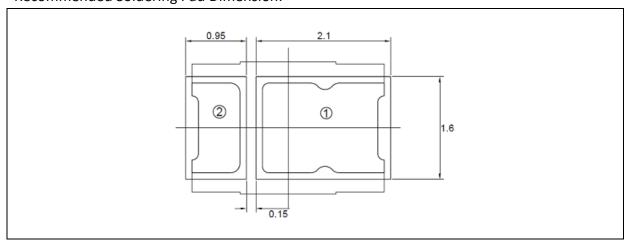
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 20mA):

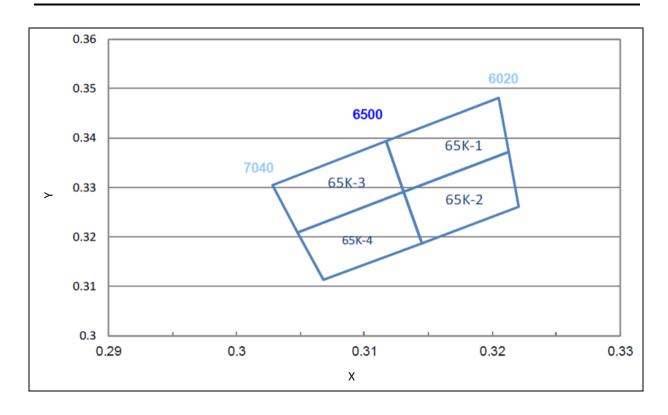
Code	Min.	Max.	Unit
1	2.8	2.9	
2	2.9	3.0	
3	3.0	3.1	
4	3.1	3.2	V
5	3.2	3.3	V
6	3.3	3.4	
7	3.4	3.5	
8	3.5	3.6	

Luminous Intensity Classifications (I_F = 20mA):

Code	Min.	Max.	Unit
W34W37	1800	2000	
X11X14	2000	2200	
X15X18	2200	2400	mcd
X19X22	2400	2600	
X23X26	2600	2800	



CIE CHROMATICITY DIAGRAM:

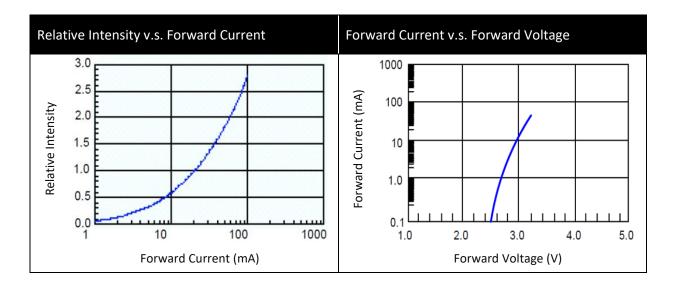


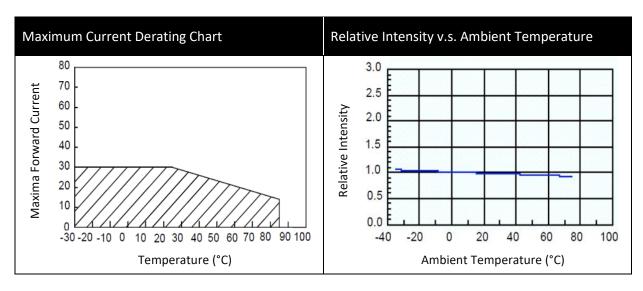
Chromaticity Coordinates Classifications (I_F = 20mA):

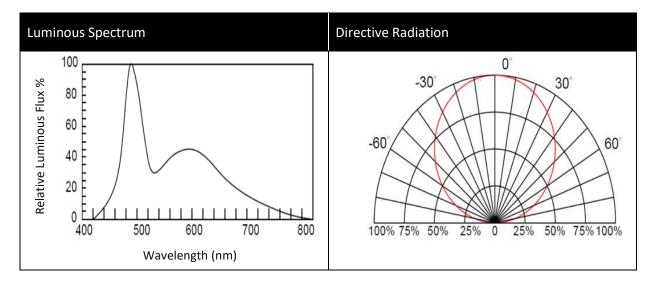
	1	1	2		3	3		4	
	Х	Υ	Х	Υ	Х	Υ	Х	Y	
65K-1	0.3205	0.3481	0.3117	0.3393	0.3131	0.3290	0.3213	0.3371	
65K-2	0.3213	0.3371	0.3131	0.3290	0.3145	0.3187	0.3221	0.3261	
65K-3	0.3117	0.3393	0.3128	0.3304	0.3048	0.3209	0.3131	0.3290	
65K-4	0.3131	0.3290	0.3048	0.3209	0.3068	0.3113	0.3145	0.3187	



ELECTRO-OPTICAL CHARACTERISTICS:



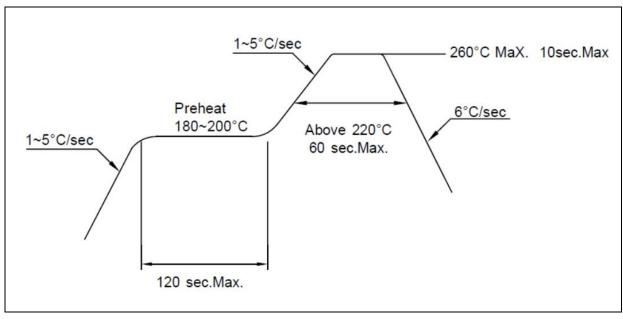






RECOMMENDED SOLDERING PROFILE:

Lead-free Solder:



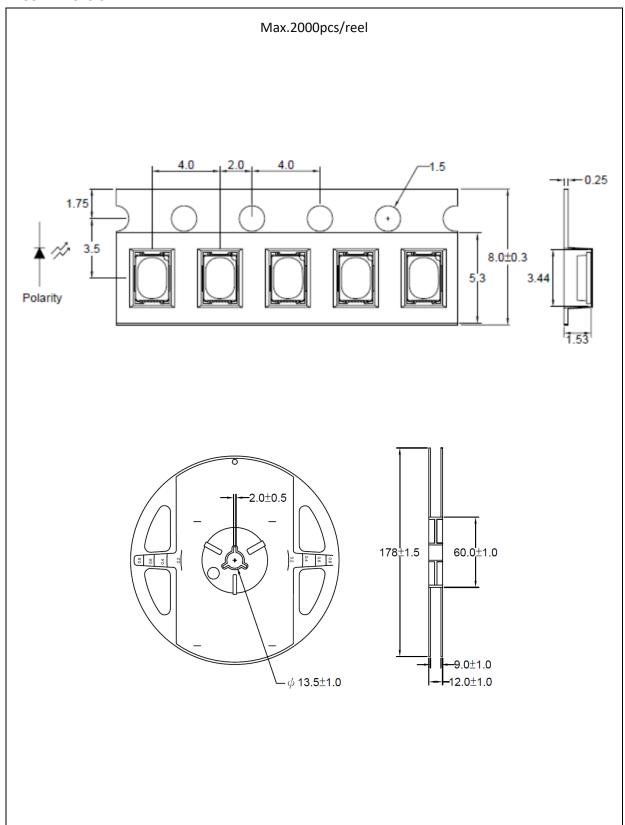
Note:

- 1. Maxima reflow soldering: 2 times.
- 2. Recommended soldering temperature is 240°C. The maxima soldering temperature should be limited to 260°C.
- 3. Before, during, and after soldering, should not apply stress on the components and PCB board.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 month at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

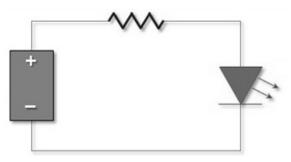
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

60±5°C x 72hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	29/03/2021	Datasheet set-up.